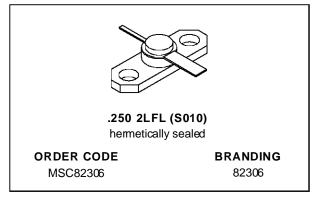


# **MSC82306**

# RF & MICROWAVE TRANSISTORS GENERAL PURPOSE AMPLIFIER APPLICATIONS

PRELIMINARY DATA

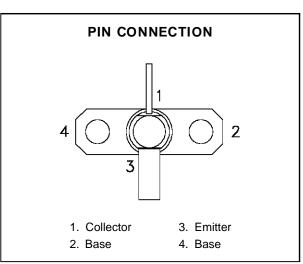
- REFRACTORY\GOLD METALLIZATION
- VSWR CAPABILITY 20:1 @ RATED CONDITIONS
- HERMETIC STRIPAC® PACKAGE
- Pout = 5.5 W MIN. WITH 9.6 dB GAIN



## **DESCRIPTION**

The MSC82306 is a common base hermetically sealed silicon NPN microwave power transistor utilizing a rugged overally die geometry. This device is capable of withstanding 20:1 load VSWR at any phase angle under rated conditions.

The MSC82306 was designed for Class C Amplifier/Oscillator applications in the 1.5 - 2.3 GHz frequency range.



#### **ABSOLUTE MAXIMUM RATINGS** $(T_{case} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit	
P <sub>DISS</sub>	Power Dissipation* (T <sub>C</sub> ≤ 50°C)	16.7	W	
Ic	Device Current*	900	mA	
Vcc	Collector-Supply Voltage*	26	V	
TJ	Junction Temperature	200	°C	
T <sub>STG</sub>	Storage Temperature	- 65 to +200	°C	

#### THERMAL DATA

R <sub>TH(j-c)</sub> Junction-Case Thermal Resistance*	9.0	°C/W
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<sup>\*</sup>Applies only to rated RF amplifier operation

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## MSC82306

## **ELECTRICAL SPECIFICATIONS** (T<sub>case</sub> = 25°C)

## STATIC

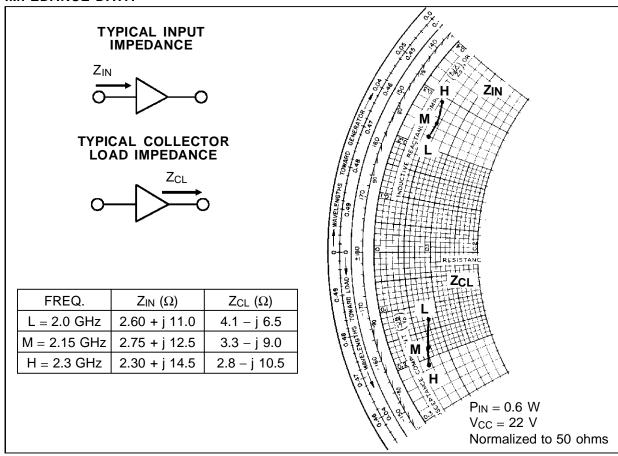
Symbol	Test Conditions	Value			IIm:4		
		Min.	Тур.	Max.	Unit		
BV <sub>CBO</sub>	I <sub>C</sub> = 1mA	$I_E = 0mA$		44			V
BV <sub>EBO</sub>	I <sub>E</sub> = 1mA	I <sub>C</sub> = 0mA		3.5	_	_	V
BVcer	IC = 5mA	$R_{BE} = 10\Omega$		44	_	_	V
Ісво	V <sub>CB</sub> = 22V			_		0.5	mA
h <sub>FE</sub>	V <sub>CE</sub> = 5V	I <sub>C</sub> = 400mA		30	_	300	_

## **DYNAMIC**

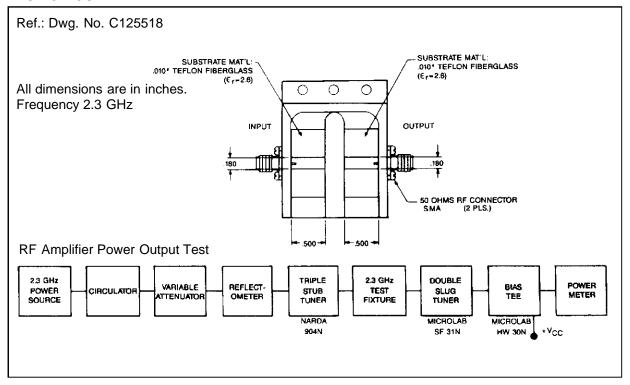
Cumbal	Took Conditions		Value			IImi4	
Symbol	Test Conditions			Min.	Тур.	Max.	Unit
Pout	f = 2.3 GHz	$P_{IN} = 0.6 W$	$V_{CC} = 22 V$	5.5	6.3	_	W
ης	f = 2.3 GHz	$P_{IN} = 0.6 \text{ W}$	$V_{CC} = 22 V$	40	45	_	%
G <sub>P</sub>	f = 2.3 GHz	$P_{IN} = 0.6 W$	$V_{CC} = 22 V$	9.6	10.2	_	dB
Сов	f = 1 MHz	V <sub>CB</sub> = 22 V		_	_	7.0	pF



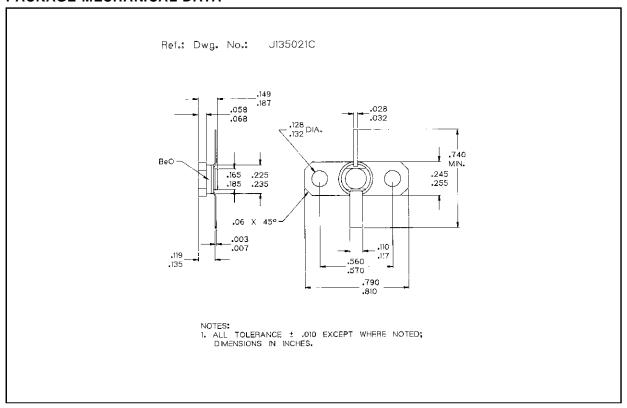
## **IMPEDANCE DATA**



## **TEST CIRCUIT**



## PACKAGE MECHANICAL DATA



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